

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: K. Takagi et al.

U.S.S.N.: 09/505,468

Examiner: D. Nakarani

Filed: 2/16/2000

Group: 1773

For: MULTILAYERED MOLDINGS

CERTIFICATE OF MAILING

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC, 20231 on 2/28/03.

By: Beth-Ann Marino

Beth-Ann Marino

Commissioner for Patents
Washington, D.C. 20231

Sir:

RESPONSE TO OFFICE ACTION

The following is in response to the Office Action mailed October 28, 2002, in the above referenced application.

Please amend the application as follows.

IN THE CLAIMS

Please amend claim 1 to read as follows:

1. A multilayered molding comprising at least two layers A and one layer B, in which the layers A are formed on both sides of the layer B, each layer A comprises a same or different thermoplastic resin compositions, the layer A has a flexural modulus according to ASTM D790 of not less than 5,000 kg/cm², the layer B comprises a